











Layer	Name	Material	Thickness	Constant	Board Layer Stack
1	Top silk (gray)				
2	Top Solder (White)	Solder Resist	O. 010mm	3.5	
3	Top Layer	Copper	0.036mm		
4	Dielectric 1	FR-4	0.090mm	4.2	
5	Internal Plane 1	Copper	0.036mm		
6	Dielectric 2	FR-4	1.250mm	4.2	
7	Internal Plane 2	Copper	0.036mm		
8	Dielectric 3	FR-4	0.090mm	4.2	
9	Bottom Layer	Copper	0.036mm		
10	Bottom Solder (White)	Solder Resist	O. 010mm	3.5	
11	Bottom silk (gray)				

Finish: immersion gold Soldermask: White

Silkscreen: pantone 431C (dark gray)

Please suggest panelization into rectangualar PCB for SMT processing